# **HEF4052B**

# Dual 4-channel analog multiplexer/demultiplexer Rev. 8 — 17 November 2011 Pro

**Product data sheet** 

#### **General description** 1.

The HEF4052B is a dual 4-channel analog multiplexer/demultiplexer with common channel select logic. Each multiplexer/demultiplexer has four independent inputs/outputs (nY0 to nY3) and a common input/output (nZ). The common channel select logic includes two select inputs (S1 and S2) and an active LOW enable input (E). Both multiplexers/demultiplexers contain four bidirectional analog switches, each with one side connected to an independent input/output (nY0 to nY3) and the other side connected to a common input/output (nZ). With  $\overline{E}$  LOW, one of the four switches is selected (low-impedance ON-state) by S1 and S2. With E HIGH, all switches are in the high-impedance OFF-state, independent of S1 and S2. If break before make is needed, then it is necessary to use the enable input.

V<sub>DD</sub> and V<sub>SS</sub> are the supply voltage connections for the digital control inputs (S1 and S2, and E). The V<sub>DD</sub> to V<sub>SS</sub> range is 3 V to 15 V. The analog inputs/outputs (nY0 to nY3, and nZ) can swing between V<sub>DD</sub> as a positive limit and V<sub>EE</sub> as a negative limit. V<sub>DD</sub> – V<sub>EE</sub> may not exceed 15 V. Unused inputs must be connected to V<sub>DD</sub>, V<sub>SS</sub>, or another input. For operation as a digital multiplexer/demultiplexer, V<sub>EE</sub> is connected to V<sub>SS</sub> (typically ground). V<sub>EE</sub> and V<sub>SS</sub> are the supply voltage connections for the switches.

#### **Features and benefits** 2.

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

# **Applications**

- Analog multiplexing and demultiplexing
- Digital multiplexing and demultiplexing
- Signal gating



#### **Dual 4-channel analog multiplexer/demultiplexer**

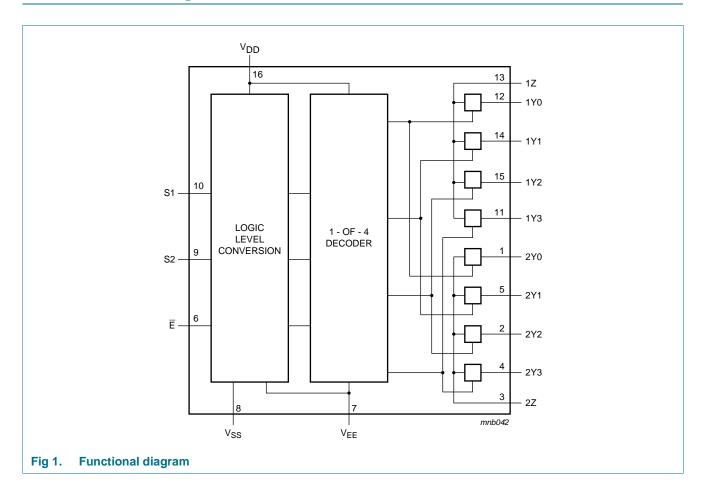
# 4. Ordering information

Table 1. Ordering information

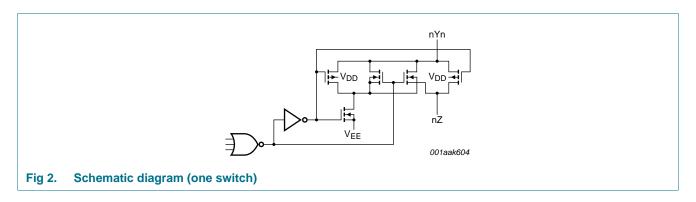
All types operate from -40~% to +125~%.

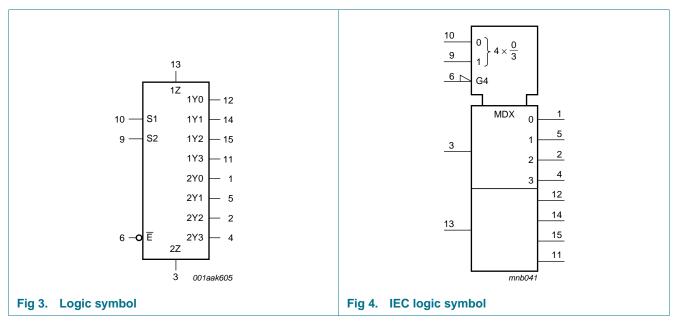
Type number	Package		
	Name	Description	Version
HEF4052BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4
HEF4052BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
HEF4052BTT	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

# 5. Functional diagram

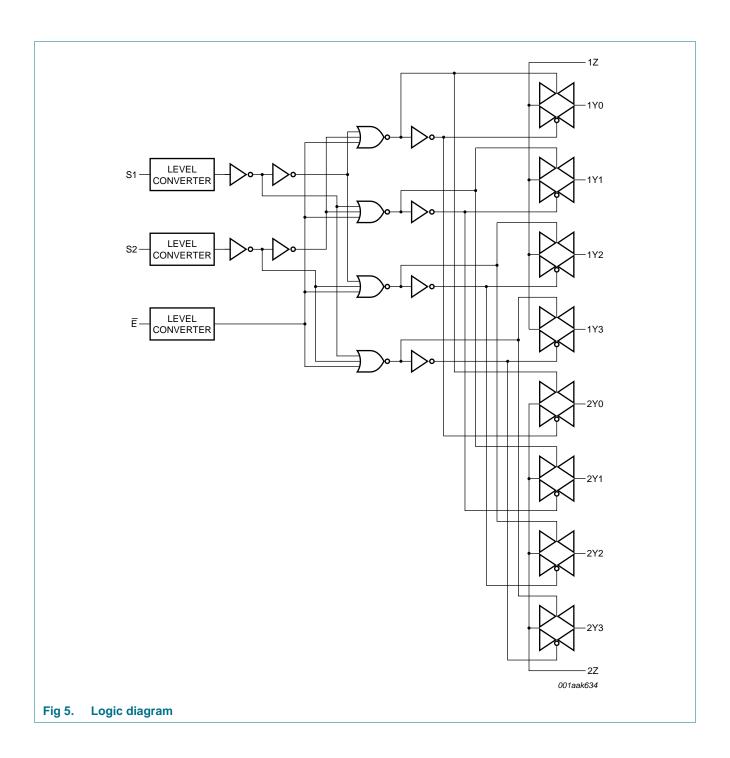


#### **Dual 4-channel analog multiplexer/demultiplexer**





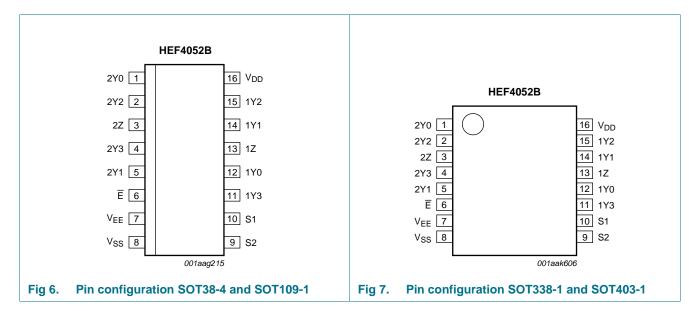
# Dual 4-channel analog multiplexer/demultiplexer



#### **Dual 4-channel analog multiplexer/demultiplexer**

# 6. Pinning information

#### 6.1 Pinning



#### 6.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
F	6	enable input (active LOW)
V <sub>EE</sub>	7	supply voltage
	0	117
V <sub>SS</sub>	8	ground supply voltage
S1, S2	10, 9	select input
1Y0, 1Y1, 1Y2, 1Y3, 2Y0, 2Y1, 2Y2, 2Y3	12, 14, 15, 11, 1, 5, 2, 4	independent input or output
1Z, 2Z	13, 3	common output or input
$V_{DD}$	16	supply voltage

#### **Dual 4-channel analog multiplexer/demultiplexer**

### 7. Functional description

#### 7.1 Function table

Table 3. Function table [1]

Input			Channel on
Ē	S2	S1	
L	L	L	nY0 to nZ
L	L	Н	nY1 to nZ
L	Н	L	nY2 to nZ
L	Н	Н	nY3 to nZ
Н	X	X	switches off

<sup>[1]</sup> H = HIGH voltage level;

# 8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to  $V_{SS} = 0 \text{ V}$  (ground).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DD}$	supply voltage		-0.5	+18	V
V <sub>EE</sub>	supply voltage	referenced to V <sub>DD</sub>	<u>[1]</u> –18	+0.5	V
I <sub>IK</sub>	input clamping current	pins Sn and $\overline{E}$ ; V <sub>I</sub> < -0.5 V or V <sub>I</sub> > V <sub>DD</sub> + 0.5 V	-	±10	mA
VI	input voltage		-0.5	$V_{DD} + 0.5$	V
I <sub>I/O</sub>	input/output current		-	±10	mA
I <sub>DD</sub>	supply current		-	50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>amb</sub>	ambient temperature		-40	+125	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[2]		
		DIP16 package	-	750	mW
		SO16 package	-	500	mW
		TSSOP16 package	-	500	mW
Р	power dissipation	per output	-	100	mW

<sup>[1]</sup> To avoid drawing V<sub>DD</sub> current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V<sub>DD</sub> current will flow out of terminals Y, and in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V<sub>DD</sub> or V<sub>EE</sub>.

For SO16 package:  $P_{tot}$  derates linearly with 8 mW/K above 70  $^{\circ}\text{C}.$ 

For SSOP16 package:  $P_{tot}$  derates linearly with 5.5 mW/K above 60 °C.

L = LOW voltage level;

X = don't care.

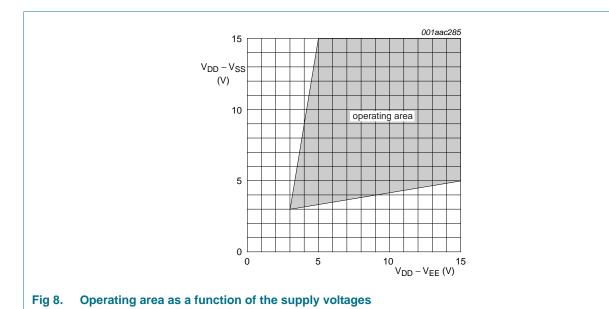
<sup>[2]</sup> For DIP16 package:  $P_{tot}$  derates linearly with 12 mW/K above 70 °C.

# Dual 4-channel analog multiplexer/demultiplexer

# 9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{DD}$	supply voltage	see Figure 8	3	-	15	V
V <sub>I</sub>	input voltage		0	-	$V_{DD}$	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall	V <sub>DD</sub> = 5 V	-	-	3.75	μs/V
	rate	V <sub>DD</sub> = 10 V	-	-	0.5	μs/V
		V <sub>DD</sub> = 15 V	-	-	0.08	μs/V



### 10. Static characteristics

#### Table 6. Static characteristics

 $V_{SS} = V_{EE} = 0 \ V$ ;  $V_I = V_{SS} \ or \ V_{DD} \ unless \ otherwise \ specified.$ 

<b>Symbol</b>	Parameter	Conditions	$V_{DD}$	T <sub>amb</sub> = -40 °C		T <sub>amb</sub> = 25 °C		T <sub>amb</sub> = 85 °C		T <sub>amb</sub> = 125 °C		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>IH</sub> HIGH-level input voltage	$ I_O  < 1 \mu A$	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V	
		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V	
		15 V	11.0	-	11.0	-	11.0	-	11.0	-	V	
V <sub>IL</sub>	V <sub>IL</sub> LOW-level	101	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
input voltage	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
I <sub>I</sub>	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μΑ

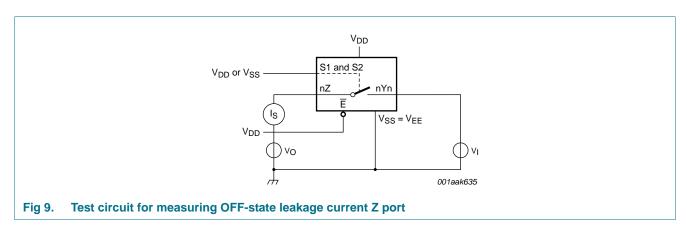
#### **Dual 4-channel analog multiplexer/demultiplexer**

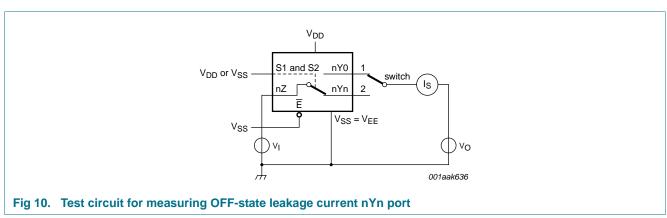
 Table 6.
 Static characteristics ...continued

 $V_{SS} = V_{EE} = 0 \text{ V}; V_I = V_{SS} \text{ or } V_{DD} \text{ unless otherwise specified.}$ 

Symbol	Parameter	Conditions	$V_{DD}$	T <sub>amb</sub> =	–40 °C	T <sub>amb</sub> = 25 °C		T <sub>amb</sub> = 85 °C		T <sub>amb</sub> = 125 °C		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
I <sub>S(OFF)</sub>	OFF-state leakage current	Z port; all channels OFF; see <u>Figure 9</u>	15 V	-	-	-	1000	-	-	-	-	nA
		Y port; per channel; see Figure 10	15 V	-	-	-	200	-	-	-	-	nA
I <sub>DD</sub>	supply current	I <sub>O</sub> = 0 A	5 V	-	5	-	5	-	150	-	150	μА
			10 V	-	10	-	10	-	300	-	300	μΑ
			15 V	-	20	-	20	-	600	-	600	μΑ
Cı	input capacitance	Sn, E inputs	-	-	-	-	7.5	-	-	-	-	pF

#### 10.1 Test circuits





#### **Dual 4-channel analog multiplexer/demultiplexer**

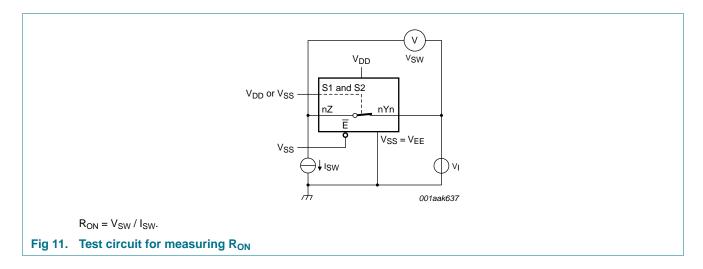
#### 10.2 On resistance

Table 7. ON resistance

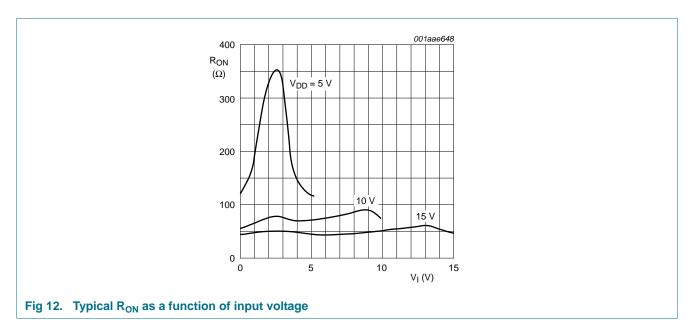
 $T_{amb} = 25$  °C;  $I_{SW} = 200~\mu A$ ;  $V_{SS} = V_{EE} = 0~V.$ 

Symbol	Parameter	Conditions	$V_{DD} - V_{EE}$	Тур	Max	Unit
R <sub>ON(peak)</sub>	ON resistance (peak)	$V_I = 0 V \text{ to } V_{DD} - V_{EE};$	5 V	350	2500	Ω
		see Figure 11 and Figure 12	10 V	80	245	Ω
			15 V	60	175	Ω
R <sub>ON(rail)</sub>	ON resistance (rail)	V <sub>I</sub> = 0 V; see <u>Figure 11</u> and <u>Figure 12</u>	15 V 60 175  gure 11 and Figure 12 5 V 115 340  10 V 50 160  15 V 40 115  5 V 120 365			Ω
			10 V	50	160	Ω
			15 V	40	115	Ω
		$V_I = V_{DD} - V_{EE}$ ; see <u>Figure 11</u> and <u>Figure 12</u>	5 V	120	365	Ω
			10 V	65	200	Ω
			15 V	50	155	Ω
$\Delta R_{ON}$	ON resistance mismatch	$V_I = 0 \text{ V to } V_{DD} - V_{EE}; \text{ see } \frac{\text{Figure 11}}{}$	5 V	25	-	Ω
	between channels		10 V	10	-	Ω
			15 V	5	-	Ω

#### 10.2.1 On resistance waveform and test circuit



#### **Dual 4-channel analog multiplexer/demultiplexer**



# 11. Dynamic characteristics

Table 8. Dynamic characteristics

 $T_{amb} = 25$  °C;  $V_{SS} = V_{EE} = 0$  V; for test circuit see <u>Figure 16</u>.

Symbol	Parameter	Conditions	V <sub>DD</sub>	Тур	Max	Unit
t <sub>PHL</sub>	HIGH to LOW propagation delay	nYn, nZ to nZ, nYn; see Figure 13	5 V	10	20	ns
			10 V	5	20 10 10 10 50 305 5 135 0 100 0 20 10 10 50 300 5 150 0 100 5 150 0 100 5 150 100 5 150 100 10	ns
			15 V	5	10	ns
		Sn to nYn, nZ; see Figure 14	5 V	150	20 n 10 n 10 n 10 n 305 n 135 n 100 n 20 n 10 n 10 n 10 n 10 n 10 n 10 n 150 n 180 n 180 n 180 n 185 n 260 n 115 n 85 n 205 n 180 n	ns
		10 V	10 V	65		ns
			15 V	50	100	ns
t <sub>PLH</sub>	LOW to HIGH propagation delay	Yn, nZ to nZ, nYn; see Figure 13	5 V	10	20	ns
			10 V	10       20         5       10         5       10         150       305         65       135         50       100         10       20         5       10         5       10         150       300         75       150         50       100         95       190         90       180         85       180         130       260         55       115         45       85         100       205         90       180	ns	
	Sr		15 V	5	10	ns
		Sn to nYn, nZ; see Figure 14 5 V 150 30 10 V 75 15	300	ns		
			10 V	75	10 n n 10 n n 305 n n 135 n n 100 n n 100 n n 100 n n 150 n n 150 n n 180 n n 185 n n 180 n n	ns
			15 V	50	100	ns
t <sub>PHZ</sub>	HIGH to OFF-state	E to nYn, nZ; see Figure 15	5 V	95	190	ns
	propagation delay		10 V       5       10       n         15 V       5       10       n         5 V       150       305       n         10 V       65       135       n         15 V       50       100       n         5 V       10       20       n         10 V       5       10       n         15 V       5       10       n         5 V       150       300       n         10 V       75       150       n         15 V       50       100       n         5 V       95       190       n         10 V       90       180       n         15 V       85       180       n         15 V       45       85       n         5 V       100       205       n         10 V       90       180       n	ns		
			15 V	85	180	ns
t <sub>PZH</sub>	OFF-state to HIGH	E to nYn, nZ; see Figure 15	5 V	130	260	ns
	propagation delay		10 V	55	115	ns
			15 V	90 180 ns 85 180 ns 130 260 ns 55 115 ns 45 85 ns	ns	
t <sub>PLZ</sub>	LOW to OFF-state	E to nYn, nZ; see Figure 15	5 V	100		
1 62	propagation delay		10 V	90	180	ns
			15 V	90	180	ns

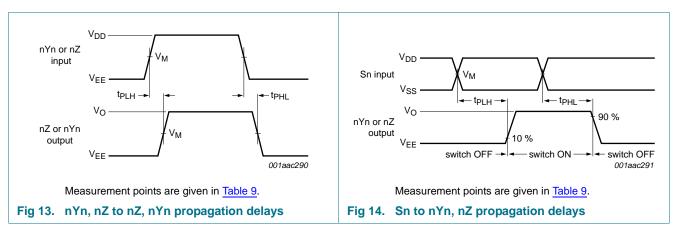
#### **Dual 4-channel analog multiplexer/demultiplexer**

 Table 8.
 Dynamic characteristics ...continued

 $T_{amb} = 25$  °C;  $V_{SS} = V_{EE} = 0$  V; for test circuit see <u>Figure 16</u>.

Symbol	Parameter	Conditions	$V_{DD}$	Тур	Max	Unit
$t_{PZL}$	OFF-state to LOW	E to nYn, nZ; see Figure 15	5 V	120	240	240 ns 100 ns
	propagation delay		10 V	50	100	ns
			15 V	35	75	ns

#### 11.1 Waveforms and test circuit



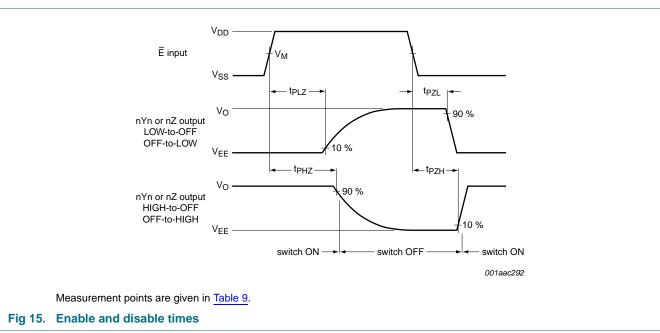


Table 9. Measurement points

Supply voltage	Input	Output
$V_{DD}$	V <sub>M</sub>	V <sub>M</sub>
5 V to 15 V	0.5V <sub>DD</sub>	0.5V <sub>DD</sub>

#### **Dual 4-channel analog multiplexer/demultiplexer**

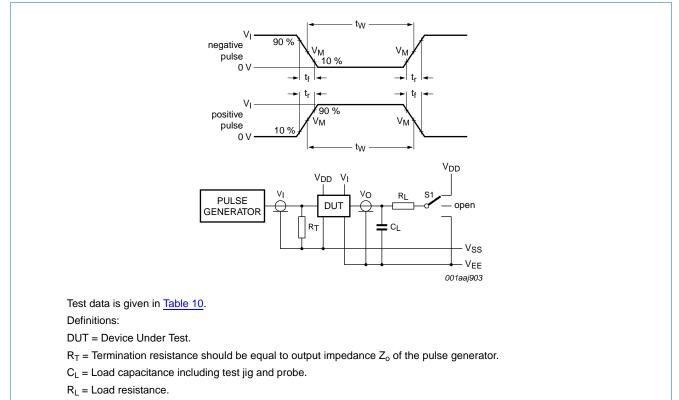


Fig 16. Test circuit for measuring switching times

#### Table 10. Test data

Input _			Load	Load S1 position						
nYn, nZ	Sn and E	t <sub>r</sub> , t <sub>f</sub>	V <sub>M</sub>	CL	$R_L$	t <sub>PHL</sub> [1]	t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	$t_{PZL}, t_{PLZ}$	other
$V_{\text{DD}}$ or $V_{\text{EE}}$	$V_{\text{DD}}$ or $V_{\text{SS}}$	$\leq$ 20 ns	$0.5V_{DD}$	50 pF	10 k $\Omega$	$V_{\text{DD}}$ or $V_{\text{EE}}$	$V_{EE}$	$V_{EE}$	$V_{DD}$	$V_{EE}$

[1] For nYn to nZ propagation delays use  $V_{\text{EE}}$ . For Sn to nYn or nZ propagation delays use  $V_{\text{DD}}$ .

#### **Dual 4-channel analog multiplexer/demultiplexer**

### 11.2 Additional dynamic parameters

Table 11. Additional dynamic characteristics

 $V_{SS} = V_{EE} = 0 \text{ V; } T_{amb} = 25 \text{ °C.}$ 

Symbol	Parameter	Conditions	$V_{DD}$	Тур	Max	Unit
THD	total harmonic distortion	see Figure 17; $R_L = 10 \text{ k}\Omega$ ; $C_L = 15 \text{ pF}$ ;	5 V	[ <u>1</u> ] 0.25	-	%
		channel ON; $V_I = 0.5V_{DD}$ (p-p); $f_i = 1$ kHz	10 V	<u>[1]</u> 0.04	-	%
		$I_{i} = I \text{ K} I Z$	15 V	<u>[1]</u> 0.04	-	%
$f_{(-3dB)}$	-3 dB frequency response	see Figure 18; $R_L = 1 \text{ k}\Omega$ ; $C_L = 5 \text{ pF}$ ;	5 V	<u>[1]</u> 13	-	MHz
		channel ON; $V_I = 0.5V_{DD}$ (p-p)	10 V	<u>[1]</u> 40	-	MHz
			15 V	<u>[1]</u> 70	-	MHz
$lpha_{iso}$	isolation (OFF-state)	see Figure 19; $f_i$ = 1 MHz; $R_L$ = 1 $k\Omega$ ; $C_L$ = 5 pF; channel OFF; $V_I$ = 0.5 $V_{DD}$ (p-p)	10 V	<u>[1]</u> –50	-	dB
V <sub>ct</sub>	crosstalk voltage	digital inputs to switch; see Figure 20; $\underline{R}_L = 10 \text{ k}\Omega$ ; $C_L = 15 \text{ pF}$ ; $\overline{E}$ or $Sn = V_{DD}$ (square-wave)	10 V	50	-	mV
Xtalk	crosstalk	between switches; see Figure 21; $f_i = 1$ MHz; $R_L = 1$ $k\Omega$ ; $V_I = 0.5V_{DD}$ (p-p)	10 V	<u>[1]</u> –50	-	dB

<sup>[1]</sup>  $f_i$  is biased at 0.5  $V_{DD}$ ;  $V_I = 0.5 V_{DD}$  (p-p).

#### Table 12. Dynamic power dissipation P<sub>D</sub>

 $P_D$  can be calculated from the formulas shown;  $V_{EE} = V_{SS} = 0$  V;  $t_r = t_f \le 20$  ns;  $T_{amb} = 25$  °C.

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Symbol	Parameter	$V_{DD}$	Typical formula for P <sub>D</sub> (μW)	where:
$P_D$	dynamic power	5 V	$P_D = 1300 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	$f_i$ = input frequency in MHz;
dissipation	10 V	$P_D = 6100 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	f <sub>o</sub> = output frequency in MHz;	
	15 V	$P_D = 15600 \times f_i + \Sigma (f_o \times C_L) \times V_{DD}^2$	$C_L$ = output load capacitance in pF;	
				$V_{DD}$ = supply voltage in V;
				$\Sigma(C_L \times f_o)$ = sum of the outputs.

#### 11.2.1 Test circuits

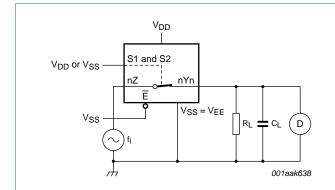


Fig 17. Test circuit for measuring total harmonic distortion

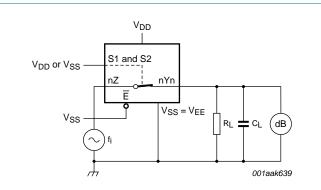
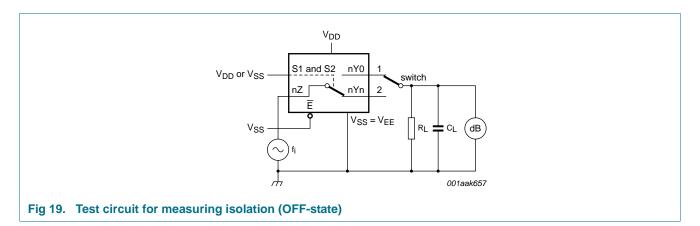
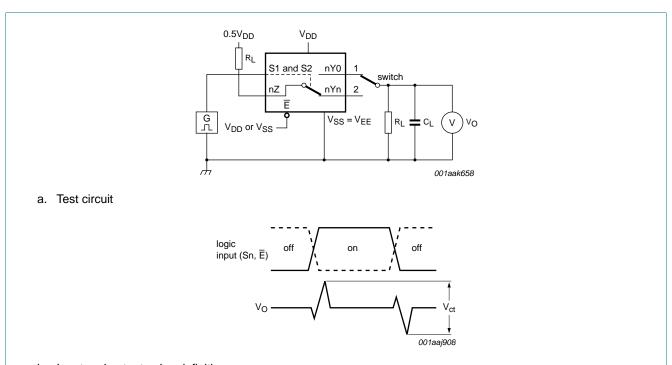


Fig 18. Test circuit for measuring frequency response

#### Dual 4-channel analog multiplexer/demultiplexer

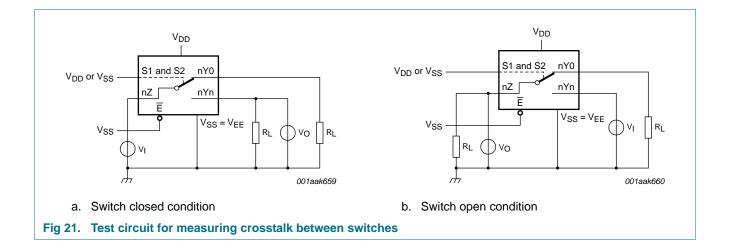




b. Input and output pulse definitions

Fig 20. Test circuit for measuring crosstalk voltage between digital inputs and switch

### Dual 4-channel analog multiplexer/demultiplexer



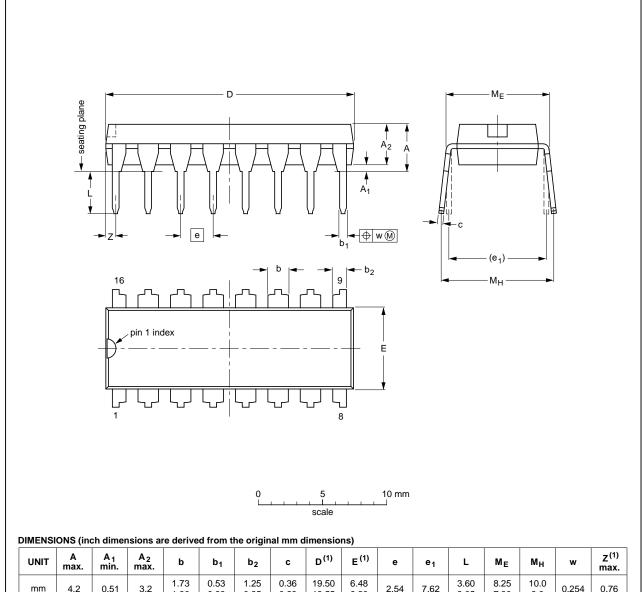
**HEF4052B NXP Semiconductors** 

#### **Dual 4-channel analog multiplexer/demultiplexer**

# 12. Package outline

#### DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	C	D <sup>(1)</sup>	E <sup>(1)</sup>	е	e <sub>1</sub>	L	ME	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.03

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

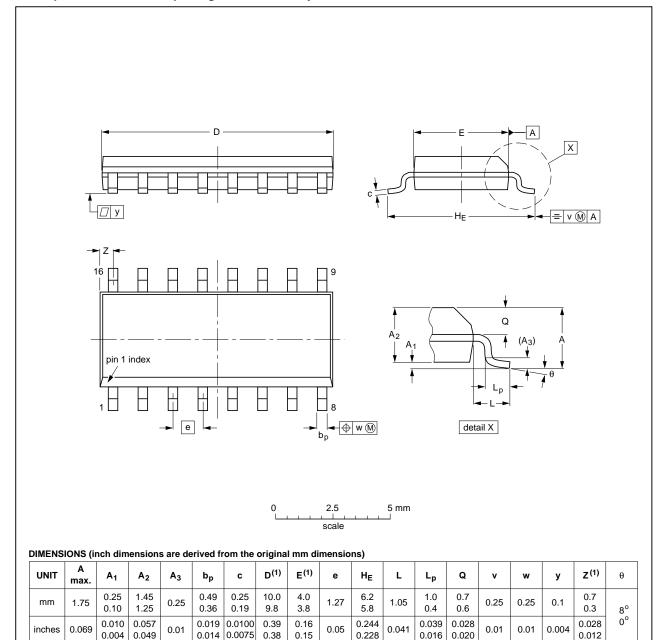
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE	
SOT38-4					<del>95-01-14</del> 03-02-13	

Fig 22. Package outline SOT38-4 (DIP16)

#### **Dual 4-channel analog multiplexer/demultiplexer**

#### SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



#### \_\_\_

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT109-1	076E07	MS-012				<del>99-12-27</del> 03-02-19

Fig 23. Package outline SOT109-1 (SO16)

HEF4052B

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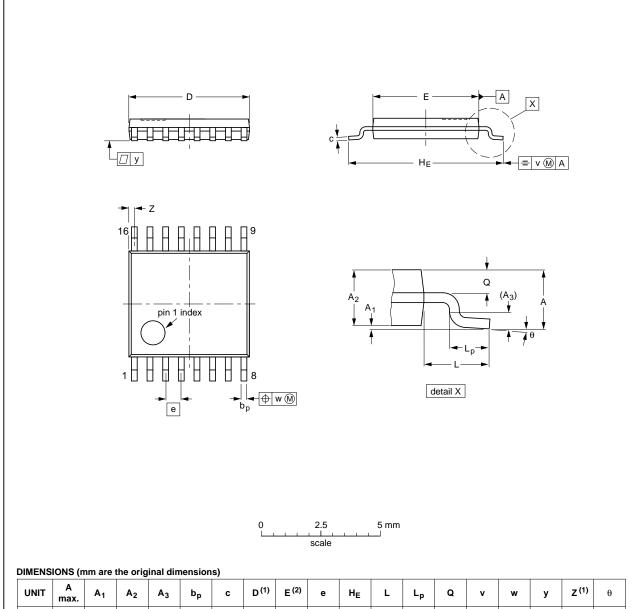
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#### **Dual 4-channel analog multiplexer/demultiplexer**

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT403-1		MO-153				<del>-99-12-27</del> 03-02-18

Fig 24. Package outline SOT403-1 (TSSOP16)

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# Dual 4-channel analog multiplexer/demultiplexer

# 13. Revision history

#### Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
HEF4052B v.8	20111117	Product data sheet	-	HEF4052B v.7
Modifications:	<ul> <li>Legal page:</li> </ul>	s updated.		
	<ul> <li>Changes in</li> </ul>	"General description", "Feat	ures and benefits" and	"Applications".
HEF4052B v.7	20100326	Product data sheet	-	HEF4052B v.6
HEF4052B v.6	20100308	Product data sheet	-	HEF4052B v.5
HEF4052B v.5	20091127	Product data sheet	-	HEF4052B v.4
HEF4052B v.4	20090924	Product data sheet	-	HEF4052B_CNV v.3
HEF4052B_CNV v.3	19950101	Product specification	-	HEF4052B_CNV v.2
HEF4052B_CNV v.2	19950101	Product specification	-	-

### **Dual 4-channel analog multiplexer/demultiplexer**

#### 14. Legal information

#### 14.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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# Dual 4-channel analog multiplexer/demultiplexer

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